



2.0A SCHOTTKY BARRIER RECTIFIER

Product Summary

3250AF	F/B260	<u>AF</u>

V _{RRM} (V)	I _O (A)	V _{F(MAX)} (V) @ +25°C	I _{R(MAX)} (mA) @ +25°C	
50	2	0.65	0.10	
60	2	0.65	0.20	

Description and Applications

The Schottky rectifier providing low V_F and excellent reverse leakage stability at high temperatures, this device is ideal for use in general rectification applications such as:

- Boost Diode
- Blocking Diode
- Recirculating Diode

Features and Benefits

- Reduced Low Forward Voltage Drop (V_F); Better Efficiency and Cooler Operation
- Reduced High-Temperature Reverse Leakage; Increased Reliability against Thermal Runaway Failure in High Temperature Operation
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: SMAF
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (§3)
- Polarity: Cathode Band
- Weight: 0.036 grams (Approximate)

SMAF



Top View

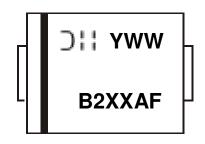
Ordering Information (Note 4)

Part Number	Case	Packaging
B250AF-13	SMAF	10,000/Tape & Reel
B260AF-13	SMAF	10,000/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

Marking Information





Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

Characteristic	Symbol	B250AF	B260AF	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _{RM}	50	60	V
Average Rectified Output Current	lo	2	2	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	5	0	Α

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Ambient (Note 5)	$R_{\theta JA}$	95	°C/W
Typical Thermal Resistance Junction to Case (Note 5)	$R_{\theta JC}$	45	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

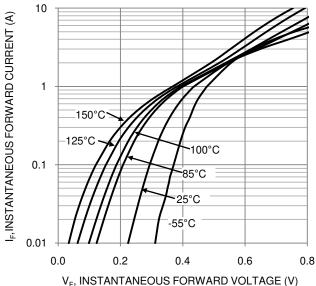
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Forward Voltage Drep	V		0.55	0.65	V	I _F = 2A, T _J = +25°C
Forward Voltage Drop	V_{F}	_	0.52	_		I _F = 2A, T _J = +125°C
B250AF		_	0.015	0.10		V _R = 50V, T _J = +25°C
Leakage Current (Note 6) B260AF	I_{R}	_	0.02	0.20	mA	$V_R = 60V, T_J = +25^{\circ}C$
		_	15	_		$V_R = 60V, T_J = +125$ °C
Typical Capacitance	Ст	_	80		pF	V _R = 4.0V, f = 1MHz

Notes:

- $5. \ Device \ mounted \ on \ FR-4 \ substrate, \ 0.4" \ x \ 0.5", \ 2oz, \ single-sided, \ PC \ boards \ with \ 0.2" \ x \ 0.25" \ copper \ pad.$
- 6. Short duration pulse test used to minimize self-heating effect.





V_F, INSTANTANEOUS FORWARD VOLTAGE (V) Figure 1. Typical Forward Characteristics

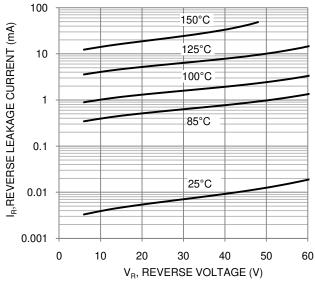


Figure 2. Typical Reverse Characteristics

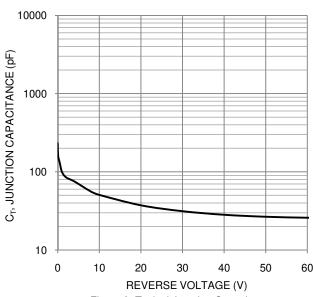


Figure 3. Typical Junction Capacitance

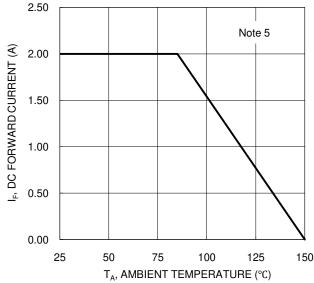


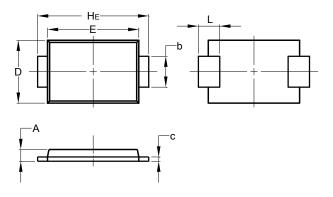
Figure 4. DC Forward Current Derating



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SMAF

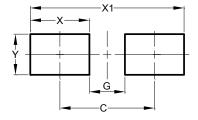


SMAF				
Dim	Min	Max		
Α	0.90	1.10		
b	1.25	1.65		
С	0.10	0.40		
D	2.25	2.95		
Е	3.95	4.60		
HE	4.80	5.60		
L	0.50	1.50		
All Dimensions in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SMAF



Dimensions	Value (in mm)
С	4.00
G	1.50
Х	2.50
X1	6.50
γ	1 70



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